

MOSFET - Power, Single N-Channel, SO8FL 40 V, 1.3 m Ω , 195 A

NTMFS1D3N04XM

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Small Footprint (5 x 6 mm) with Compact Design
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

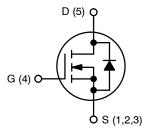
- Motor Drive
- Battery Protection
- ORing

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V_{DSS}	40	V	
Gate-to-Source Voltage	DC	V_{GS}	±20	V
Continuous Drain Current	T _C = 25°C	I _D	195	Α
	T _C = 100°C		138	
Power Dissipation	T _C = 25°C	P _D	90	W
Continuous Drain Current	T _A = 25°C	I _{DA}	40	Α
$R_{\theta JA}$	T _A = 100°C		28	
Pulsed Drain Current	$T_C = 25$ °C, $t_p = 10 \mu s$	I _{DM}	1175	Α
Operating Junction and Storag Range	T _J , T _{STG}	-55 to +175	°C	
Source Current (Body Diode)	Is	74.5	Α	
Single Pulse Avalanche Energ (I _{PK} = 11.1 A)	E _{AS}	306	mJ	
Lead Temperature for Solderin (1/8" from case for 10 s)	TL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
40 V	1.3 m Ω @ V_{GS} = 10 V	195 A



N-CHANNEL MOSFET



SO-8FL CASE 488AA (DFN5)

1D3N4 AYWZZ

1D3N4 = Specific Device Code

A = Assembly Location

Y = Year W = Work Week

ZZ = Assembly Lot Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	1.67	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 1, 2)	$R_{\theta JA}$	40.1	

^{1.} Surface mounted on FR4 board using 650 mm², 2 oz Cu pad.

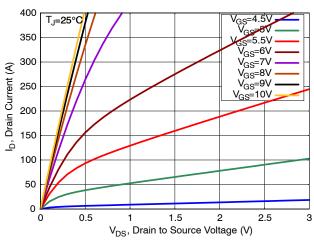
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/$ ΔT_J	I _D = 1 mA, Referenced to 25°C		15		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, T _J = 25°C			10	μΑ
		V _{DS} = 40 V, T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 25°C		1.17	1.3	mΩ
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 100 \mu A, T_J = 25^{\circ}C$	2.5	3.0	3.5	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(TH)}/$ ΔT_J	$V_{GS} = V_{DS}, I_{D} = 100 \mu A$		-7.23		mV/°C
Forward Trans-conductance	9FS	V _{DS} = 5 V, I _D = 20 A		105		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				•	
Input Capacitance	C _{ISS}	V _{GS} = 0 V, V _{DS} = 20 V, f = 1 MHz		2473		pF
Output Capacitance	C _{OSS}			1763		
Reverse Transfer Capacitance	C _{RSS}			37.3		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DD} = 20 V; I _D = 50 A		38.5		nC
Threshold Gate Charge	Q _{G(TH)}			7.27		
Gate-to-Source Charge	Q _{GS}			11.3		
Gate-to-Drain Charge	Q_{GD}			7.07		
Gate Resistance	R_{G}	f = 1 MHz		1.21		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	Resistive Load,		20		ns
Rise Time	t _r	$V_{GS} = 0/10 \text{ V}, V_{DD} = 20 \text{ V},$ $I_{D} = 50 \text{ A}, R_{G} = 0 \Omega$		6.27		
Turn-Off Delay Time	t _{d(OFF)}			29.2		
Fall Time	t _f			5.47		
SOURCE-TO-DRAIN DIODE CHARACT	ERISTICS				•	
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V, I _S = 20 A, T _J = 25°C		0.79	1.2	V
		V _{GS} = 0 V, I _S = 20 A, T _J = 125°C		0.63		1
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, I_{S} = 50 \text{ A},$		47.1		ns
Charge Time	ta	dl/dt = 100 A/μs, V _{DD} = 20 V		23.4		1
Discharge Time	t _b			23.7		1
Reverse Recovery Charge	Q _{RR}	1		53.7		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

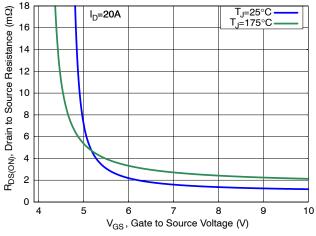
TYPICAL CHARACTERISTICS



400 V_{DS}=5V 350 V_{DS}=5V 300 V

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



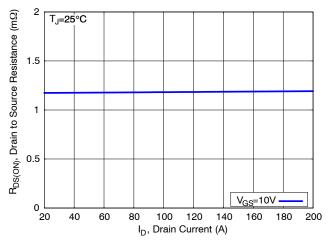
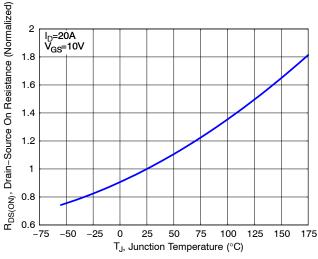


Figure 3. On-Resistance vs. V_{GS}

Figure 4. On-Resistance vs. Drain Current and Gate Voltage



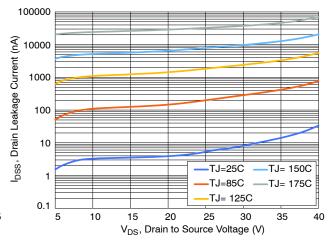


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

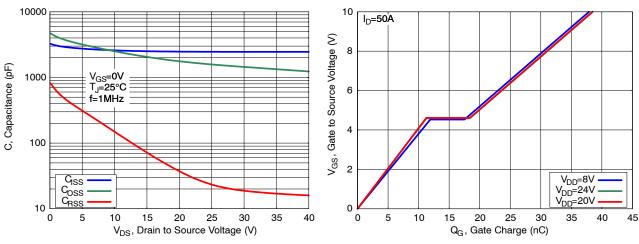


Figure 7. Capacitance Characteristics

Figure 8. Gate-to-Source Voltage vs. Total Charge

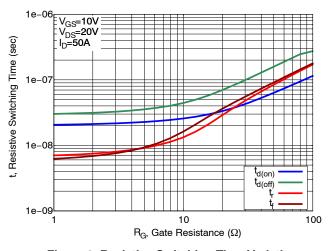


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

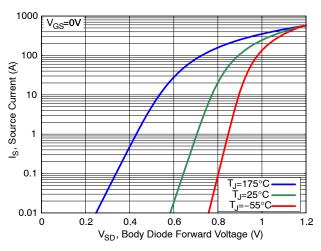


Figure 10. Diode Forward Voltage vs. Current

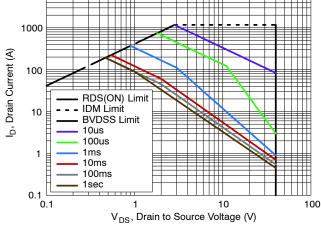


Figure 11. Safe Operating Area (SOA)

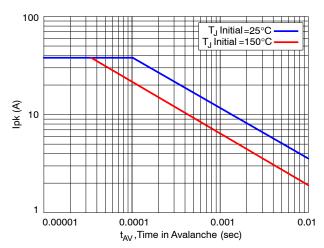


Figure 12. Avalanche Current vs Pulse Time (UIS)

TYPICAL CHARACTERISTICS

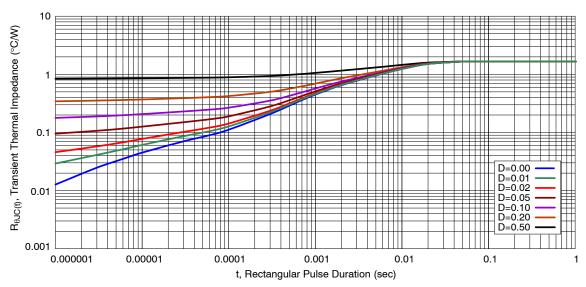


Figure 13. Transient Thermal Response

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS1D3N04XMT1G	1D3N4	SO-8FL (DFN5) (Pb-Free)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.125 REF			
M	3.00	3.40	3.80	
θ	0 °		12 °	

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code

= Lot Traceability

= Assembly Location Α

Υ = Year W = Work Week

ZZ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.





DETAIL A

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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